Declaration For Patent Application

專利申請宣誓書

如下所述發明者,我在此宣告:	As a below named inventor, I hereby declare that:			
我的地址和國籍身份都列在底下我的姓名之後:	My residence address and citizenship are as stated below next to my name,			
我相信我是原創的、第一個和單獨的發明者(若只列出一人姓名)或是原創的、第一個和共同的發明者(若列出一人以上姓名)。我要求的主題及申請的專利是關於發明	I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled HEAT DISSIPATION STRUCTURE			
	the specification of which			
其說明書: (註明一項) ☑隨同附上 □於	(check one) is attached hereto. was filed on as Application Serial No. and was amended on (if applicable)			
我在此陳述我已經再次查看並明瞭以上所指的說明書的內容,包括上述的要求及修正。	I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.			
我,按照聯邦規則法典第三十七冊第一·五六條(甲)的條文,認知我提供與審查此申請書有關的重要資料的義務。	I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).			
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Chinese Language Declaration

我,按照聯邦法典第三十五冊第一一九條的條文, 依據下列外國專利申請書或發明者證明申請書在此 要求受益優先權,並指出任何上述要求優先權所依 據的外國專利申請書或發明者證明申請書其申請日 在本申請書的申請日之前。 I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

先前外國申請: Prior Foreign Applic	cation(s)			<u>Pr</u>	優先權要求 iority Claimed
			_	┌	_
(號碼) (Number)		(國名) (Country)	申請月/日/年) (Month/Day/ Year Filed	是 iled) Ye	
					П
(號碼) (Number)		(國名) (Country)	申請月/日/年) (Month/Day/ Year F	是 iled) Yes	_
(號碼) (Number)		(國名) (Country)	申請月/日/年) (Month/Day/ Year Fi	是 iled) Ye	_
我,按照聯邦法典 依據下列的美國申 求的主題未曾依聯 條文在先前的申請 書的申請日和本申 日之間的,我,依 五六條(甲)的條例	請書要求受益。 邦法典第三十五 書中透露的,而 請書的國家或國 聯邦規則法典領	至於其中每個要	I hereby claim the be States Code, §120 application(s) listed subject matter of e application is not di States application in first paragraph of Tif §112, I acknowledge information as defined Regulations, §1.56(a) filing date of the prior or PCT international fi	below and, in the conscious of the conscious of the conscious of the conscious of the duty to distribute of the duty to distribute of the conscious of the cons	United States insofar as the claims of this e prior United rovided by the States Code, sclose material ode of Federal ed between the ind the national
(申請順次號碼)	(申請日期)	(狀況) (已專利,申請中)	(Application Serial No.)	(Filing Date)	(status) (patented, pending, abandoned)
(申請順次號碼)	(申請日期)	(狀況) (已專利,申請中)	(Application Serial No.)	(Filing Date)	(status) (patented, pending, abandoned)
我在此聲明所有就我自己知識之下所做的一切陳述			I hereby declare that all statements made herein of		

我在此聲明所有就我自己知識之下所做的一切陳述 均屬真實的,而且依資料和信念所做的一切陳述也 相信均是真實的。還有我了解,根據聯邦法典第十 八冊第一〇〇一節的規定,有企圖不實或類似的聲 明時,應受罰款或監禁的,或兩項同時的處分。像 這些企圖不實的聲明會危害到本申請書的合法性或 危害到任何專利的批准。 I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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	Citizenship
中華民國	
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發明者的簽名 · 日期	Inventor's signature Date
住址	Residence
図籍	Citizenship
中華民國	
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